2-input NAND gate; open drain Rev. 10 — 12 January 2022

1. General description

The 74LVC1G38 is a single 2-input NAND gate with open-drain output. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant outputs for interfacing with 5 V logic
- High noise immunity
- ±24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Open drain outputs
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Latch-up performance exceeds 250 mA
- · Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V).
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +125 °C.



2-input NAND gate; open drain

3. Ordering information

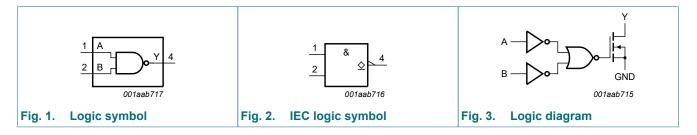
Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G38GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LVC1G38GV	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74LVC1G38GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74LVC1G38GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74LVC1G38GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202
74LVC1G38GX	-40 °C to +125 °C	X2SON5	plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.32 mm	SOT1226-

4. Marking

Table 2. Marking	
Type number	Marking code[1]
74LVC1G38GW	YB
74LVC1G38GV	YB
74LVC1G38GM	ҮВ
74LVC1G38GN	YB
74LVC1G38GS	YB
74LVC1G38GX	YB

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

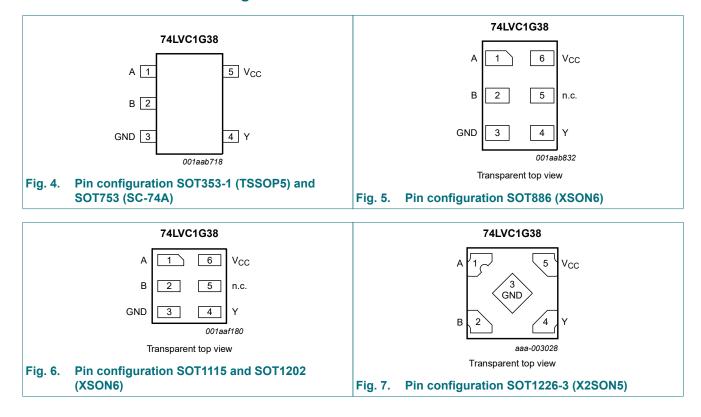
5. Functional diagram



74LVC1G38

6. Pinning information

6.1. Pinning



6.2. Pin description

Symbol	Pin	Pin		
	TSSOP5, SC-74A and X2SON5	XSON6		
A	1	1	data input	
В	2	2	data input	
GND	3	3	ground (0 V)	
Y	4	4	data output	
n.c.	-	5	not connected	
V _{CC}	5	6	supply voltage	

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF state.

Input		Output
Α	В	Y
L	L	Z
L	Н	Z
Н	L	Z
Н	Н	L

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V		-50	-	mA
VI	input voltage		[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V		-	±50	mA
Vo	output voltage	Active mode	[1]	-0.5	+6.5	V
		Power-down mode; $V_{CC} = 0 V$	[1]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V \text{ to } V_{CC}$		-	±50	mA
I _{CC}	supply current			-	100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.

For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.

For SOT1115 (XSON6) package: P_{tot} derates linearly with 3.2 mW/K above 71 $^\circ\text{C}.$

For SOT1202 (XSON6) package: Ptot derates linearly with 3.3 mW/K above 74 °C.

For SOT1226-3 (X2SON5) package: Ptot derates linearly with 3.0 mW/K above 67 °C.

9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	5.5	V
		Disable mode; V_{CC} = 1.65 V to 5.5 V	0	-	5.5	V
		Power-down mode; V _{CC} = 0 V	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		V _{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

Table 6. Recommended operating conditions

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T _{amb} = -4	40 °C to +85 °C				1	
VIH	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}				
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.3	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.4	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.55	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.55	V
l _l	input leakage current	V_1 = 5.5 V or GND; V_{CC} = 0 V to 5.5 V	-	±0.1	±1	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or } GND;$ $V_{CC} = 5.5 \text{ V}$	-	±0.1	±2	μA
I _{OFF}	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±2	μA
I _{CC}	supply current	V_{I} = 5.5 V or GND; V_{CC} = 1.65 V to 5.5 V; I_{O} = 0 A	-	0.1	4	μA
ΔI _{CC}	additional supply current	V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V; per pin	-	5	500	μA
CI	input capacitance		-	2.5	-	pF

2-input NAND gate; open drain

Symbol	Parameter	Conditions	Min	Typ[1]	Мах	Unit
T _{amb} = -4	40 °C to +125 °C			I	1	
VIH	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	0.35 × V _{CC}	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}				
		I_0 = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.1	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.70	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.45	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.60	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.80	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.80	V
l _l	input leakage current	V_1 = 5.5 V or GND; V_{CC} = 0 V to 5.5 V	-	-	±1	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or } GND;$ $V_{CC} = 5.5 \text{ V}$	-	-	±2	μA
I _{OFF}	power-off leakage current	$V_{1} \text{ or } V_{0} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	-	±2	μA
I _{CC}	supply current	V_{I} = 5.5 V or GND; V_{CC} = 1.65 V to 5.5 V; I_{O} = 0 A	-	-	4	μA
ΔI _{CC}	additional supply current	$V_I = V_{CC} - 0.6 V; I_O = 0 A;$ $V_{CC} = 2.3 V to 5.5 V; per pin$	-	-	500	μA

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

74LVC1G38

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 9.

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Typ[1]	Max	Min	Мах	
t _{pd}	propagation delay	A, B to Y; see Fig. 8 [2]						
		V _{CC} = 1.65 V to 1.95 V	1.0	3.0	10.0	1.0	12.5	ns
		V _{CC} = 2.3 V to 2.7 V	0.5	1.8	6.0	0.5	7.5	ns
		V _{CC} = 2.7 V	0.5	2.5	5.0	0.5	6.5	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.3	4.5	0.5	5.7	ns
		V_{CC} = 4.5 V to 5.5 V	0.5	1.5	3.9	0.5	4.9	ns
C _{PD}	power dissipation capacitance	$V_{CC} = 3.3 \text{ V}; $ [3] V _I = GND to V _{CC}	-	6	-	-	-	pF

Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively. [1]

[2]

 t_{pd} is the same as t_{PZL} and t_{PLZ} . C_{PD} is used to determine the dynamic power dissipation (P_D in µW). [3]

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output$ frequency in MHz;

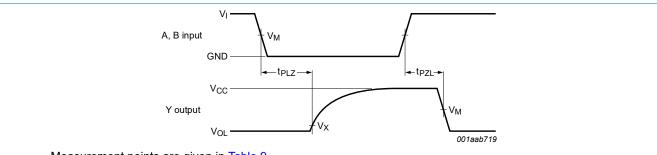
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

11.1. Waveforms and test circuit



Measurement points are given in Table 9.

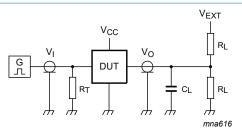
Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

The input (A, B) to output (Y) propagation delays Fig. 8.

Table 9. Measurement points

Supply voltage	Input	Output		
V _{cc}	V _M	V _M	V _X	
1.65 V to 1.95 V	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	
2.3 V to 2.7 V	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	
2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	
3.0 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	
4.5 V to 5.5 V	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.3 V	

2-input NAND gate; open drain



Test data is given in <u>Table 10</u>.

Definitions for test circuit:

R_L = Load resistance;

 C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator;

 V_{EXT} = External voltage for measuring switching times.

Fig. 9. Test circuit for measuring switching times

Table 10. Test data

Supply voltage Input Load		Load	ad		
V _{cc}	VI	t _r , t _f	CL	RL	t _{PZL} , t _{PLZ}
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	V _{CC}
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	V _{CC}
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	V _{CC}
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	V _{CC}
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	V _{CC}

2-input NAND gate; open drain

12. Package outline

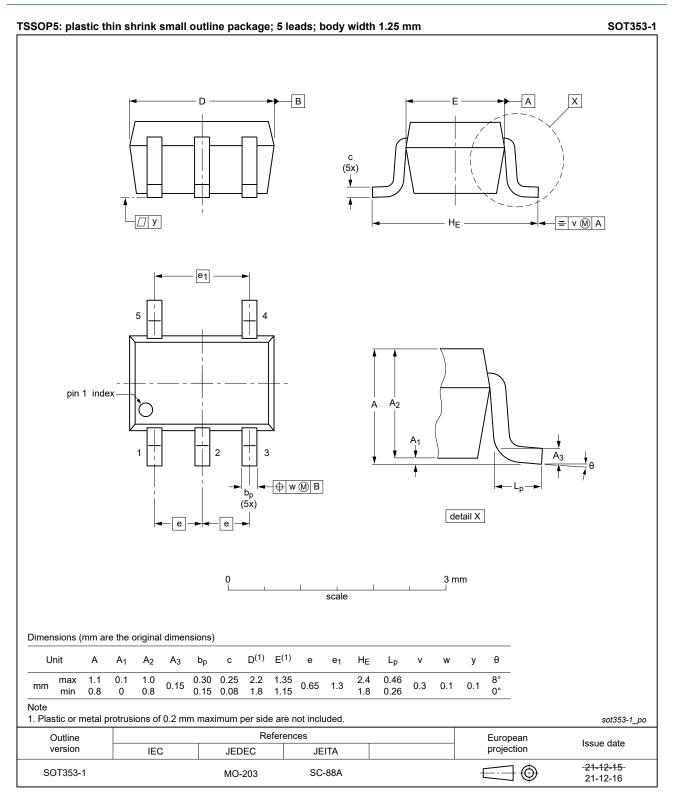


Fig. 10. Package outline SOT353-1 (TSSOP5)

2-input NAND gate; open drain



SOT753

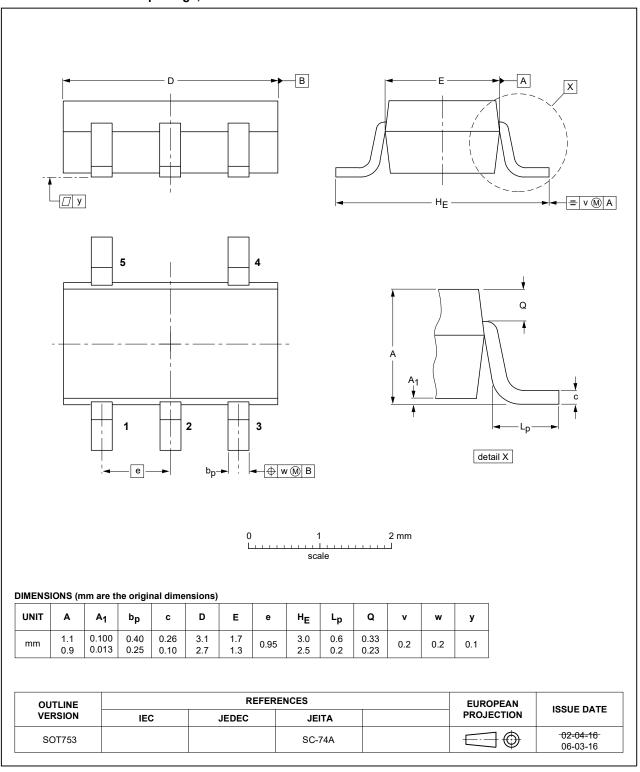


Fig. 11. Package outline SOT753 (SC-74A)

2-input NAND gate; open drain

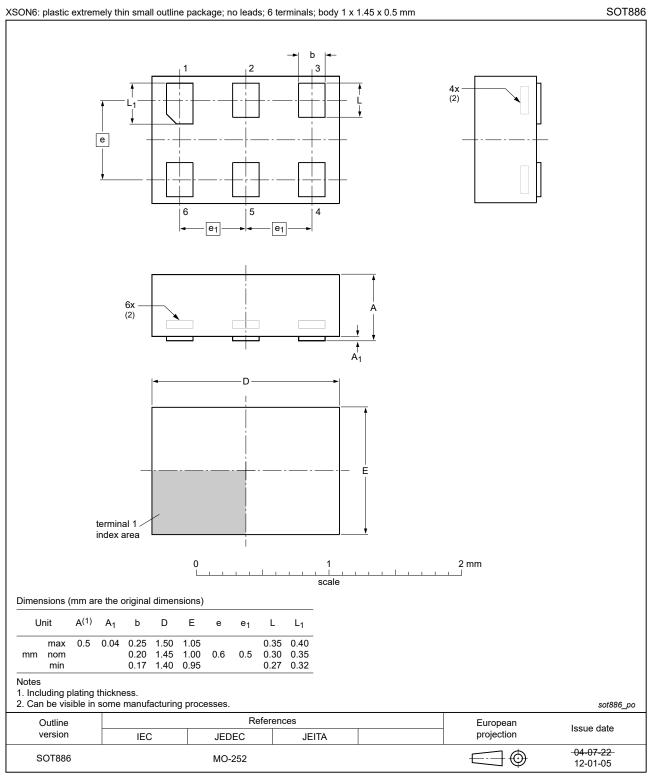
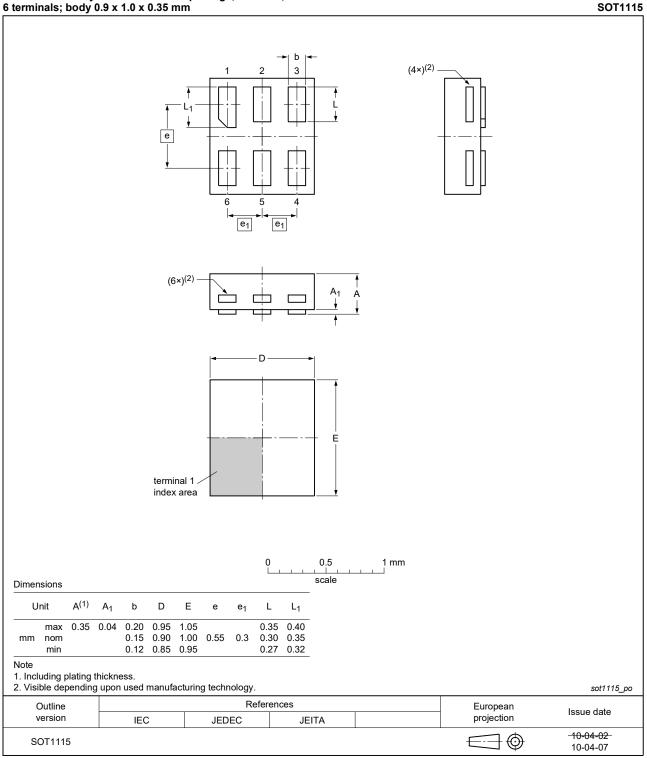


Fig. 12. Package outline SOT886 (XSON6)

2-input NAND gate; open drain

XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

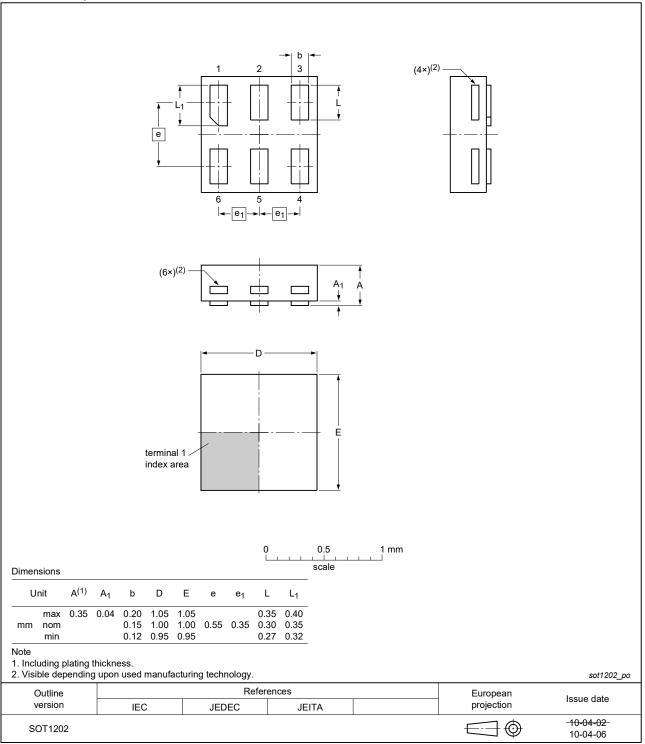




SOT1202

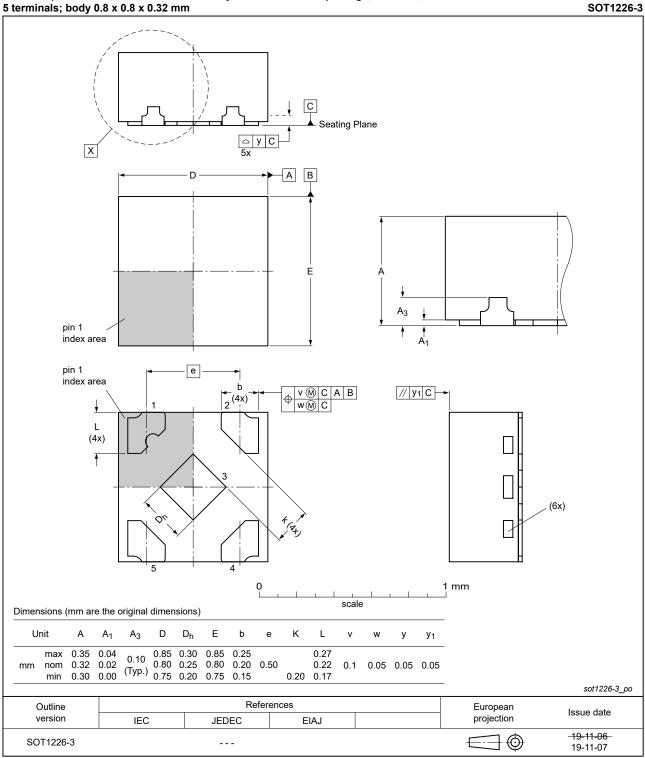
2-input NAND gate; open drain

XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm





2-input NAND gate; open drain



X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.32 mm

Fig. 15. Package outline SOT1226-3 (X2SON5)

13. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC1G38 v.10	20220112	Product data sheet	-	74LVC1G38 v.9	
Modifications:	• Fig. 10: Package outline drawing SOT353-1 (TSSOP5) has changed.				
74LVC1G38 v.9	20210518	Product data sheet	-	74LVC1G38 v.8	
Modifications:	 SOT1226 (X2SON5) package changed to SOT1226-3 (X2SON5) package. Type number 74LVC1G38GF (SOT891/XSON6) removed. <u>Section 1</u> updated. <u>Table 5</u>: P_{tot} total power dissipation and derating values updated. 				
74LVC1G38 v.8	20161207	Product data sheet	-	74LVC1G38 v.7	
Modifications:	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.				
74LVC1G38 v.7	20121004	Product data sheet	-	74LVC1G38 v.6	
Modifications:	Pin configuration SOT1226 (<u>Fig. 7</u>) modified.				
74LVC1G38 v.6	20120702	Product data sheet	-	74LVC1G38 v.5	
Modifications:	 Added type number 74LVC1G38GX (SOT1226) Package outline drawing of SOT886 (Fig. 12) modified. 				
74LVC1G38 v.5	20111206	Product data sheet	-	74LVC1G38 v.4	
Modifications:	Legal pages updated.				
74LVC1G38 v.4	20101005	Product data sheet	-	74LVC1G38 v.3	
74LVC1G38 v.3	20070827	Product data sheet	-	74LVC1G38 v.2	
74LVC1G38 v.2	20060913	Product data sheet	-	74LVC1G38 v.1	
74LVC1G38 v.1	20041018	Product data sheet	-	-	

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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2-input NAND gate; open drain

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